# imall

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### To Our Customers

Continuing it's rich tradition of partnering with high quality Japanese semiconductor suppliers, CEL is now partnering with THine from May of 2015 onwards.



### THC63LVDM83D

#### 24bit COLOR LVDS TRANSMITTER

#### General Description

The THC63LVDM83D transmitter is designed to support pixel data transmission between Host and Flat Panel Display up to 1080p/WUXGA resolutions.

The THC63LVDM83D converts 28bits of LVCMOS data into four LVDS data streams. The transmitter can be programmed for rising edge or falling edge clock through a dedicated pin. At a transmit clock frequency of 160MHz, 24bits of RGB data and 4bits of timing and control data (HSYNC, VSYNC, DE, CONT1) are transmitted at an effective rate of 1120Mbps per LVDS channel.

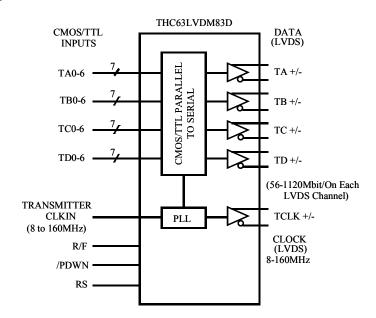
#### Application

- •Medium and Small Size Panel
- Tablet PC / Notebook PC
- Security Camera / Industrial Camera
- ·Multi Function Printer
- Industrial Equipment
- Medical Equipment Monitor

#### **Features**

- ·Compatible with TIA/EIA-644 LVDS Standard
- •7:1 LVDS Transmitter
- Operating Temperature Range : 0 to +70°C
- •No Special Start-up Sequence Required
- Spread Spectrum Clocking Tolerant up to 100kHz Frequency
- Modulation and +/-2.5% Deviations.
- Wide Dot Clock Range: 8 to 160MHz Suited for TV Signal : NTSC(12.27MHz) - 1080p(148.5MHz)
- PC Signal : QVGA(8MHz) WUXGA(154MHz) • 56pin TSSOP Package
- •1.2V to 3.3V LVCMOS/ inputs are supported.
- •LVDS swing is reducible as 200mV by RS-pin to reduce EMI and power consumption.
- · PLL requires no external components.
- ·Power Down Mode.
- · Input clock triggering edge is selectable by R/F-pin
- •EU RoHS Compliant.

#### Block Diagram







#### Pin Diagram

	THC63LVDM83D	
RS 1 TD1 2 TA5 3 TA6 4 GND 6 TB1 7 TD2 9 TD3 10 TB2 12 GND 14 TB3 12 GND 14 TB5 16 TD4 15 TD4 15 TD4 15 TD4 17 TD5 19 TC0 21 TC1 22 TC2 23 TC3 24 TC5 28		56       TA4         55       TA3         54       TA2         53       GND         52       TA1         51       TA0         50       TD0         49       LVDS GND         48       TA-         47       TA+         46       TB-         45       TB+         44       LVDS VCC         43       LVDS GND         42       TC-         41       TC+         40       TCLK-         39       TCLK+         38       TD-         37       TD+         36       LVDS GND         35       PLL GND         34       PLL VCC         33       PLL GND         32       /PDWN         31       CLK IN         30       TC6         29       GND

Figure 2. Pin Diagram



#### Pin Description

Pin Name	Pin #	Direction	Туре	Description	
TA+, TA-	47, 48				
TB+, TB-	45, 46	]		LVDS Data Out	
TC+, TC-	41, 42	Output	LVDS	LVDS Data Out	
TD+, TD-	37, 38	Output	LVDS		
TCLK+,	39, 40			LVDS Clock Out	
TCLK-					
TA0 ~ TA6	51, 52, 54, 55, 56, 3,				
TB0 ~ TB6	4 6, 7, 11, 12, 14, 15,				
TC0 ~ TC6	19 20, 22, 23, 24, 27, 28,	-		Pixel Data Input	
100~100	20, 22, 23, 24, 27, 28, 30				
TD0 ~ TD6	50, 2, 8, 10, 16, 18,				
	25 32				
/PDWN	32			H : Normal Operation	
				L : Power Down (All outputs are Hi-Z)	
RS	1	la se d		LVDS Swing Mode, VREF Select See Fig.8,	
		Input	LVCMOS	9	
				RS LVDS Small Swing	
				Swing Input Support	
				VCC 350mV N/A	
				$0.6 \sim 1.4 V$ 350mV RS=VREF	
				GND 200mV N/A	
				VREF : is Input Reference Voltage	
R/F	17			Input Clock Triggering Edge Select	
				H : Rising Edge	
				L : Falling Edge	
CLKIN	31			Input Clock	
VCC	9, 26			Power Supply Pins for LVCMOS inputs and	
				digital circuit.	
GND	5, 13, 21, 29, 53			Ground Pins for LVCMOS Inputs and Digital	
		Power	-	Circuitry.	
LVDS VCC	44			Power Supply Pins for LVDS Outputs.	
LVDS GND	36, 43 49			Ground Pins for LVDS Outputs.	
PLL VCC	34			Power Supply Pin for PLL Circuitry.	
PLL GND	33, 35			Ground Supply Pin for PLL Circuitry.	

Table 1. Pin Description



#### Absolute Maximum Ratings

Parameter	Min	Max	Unit
Supply Voltage (VCC)	-0.3	+4.0	V
LVCMOS Input Voltage	-0.3	VCC + 0.3	V
LVDS Output Pin	-0.3	VCC + 0.3	V
Output Current	-30	30	mA
Junction Temperature	-	+125	О°
Storage Temperature	-55	+150	°C
Reflow Peak Temperature	-	+260	°C
Reflow Peak Temperature Time	-	10	sec
Maximum Power Dissipation @+25°C	-	1.8	W

 Table 2. Absolute Maximum Ratings

#### **Recommended Operating Conditions**

Symbol	Parameter	Min	Тур	Max	Unit
-	All Supply Voltage	3.0	3.3	3.6	V
Та	Operating Ambient Temperature	0	25	+70	°C
-	Clock Frequency	8	-	160	MHz

#### Table 3. Recommended Operating Conditions

"Absolute Maximum Ratings" are those values beyond which the safety of the device can not be guaranteed. They are not meant to imply that the device should be operated at these limits. The tables of "Electrical Characteristics Table4, 5, 6, 7" specify conditions for device operation.

"Absolute Maximum Rating" value also includes behavior of overshooting and undershooting.

#### Equivalent LVDS Output Schematic Diagram

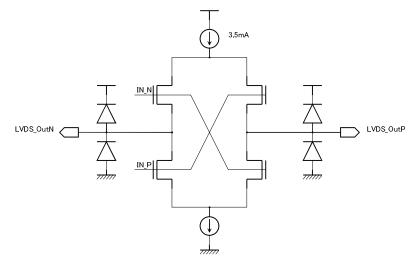


Figure 3. LVDS Output Schematic Diagram

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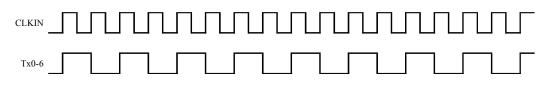
#### Power Consumption

Over recommended operating supply and temperature range unless otherwise specified						ecified	
Symbol	Parameter		Conditions		Тур*	Max	Unit
		RL=100Ω, C	L=5pF, f=85M	Hz, RS=VCC	61	67	mA
		RL=100Ω, RS=VCC	CL=5pF,	f=135MHz,	77	83	mA
I <sub>TCCW</sub>	LVDS Transmitter Operating Current	RL=100Ω, RS=VCC	CL=5pF,	f=160MHz,	84	92	mA
TCCW	Worst Case Pattern (Fig.4)	RL=100Ω, C	L=5pF, f=85M	Hz, RS=GND	50	56	mA
	(1 19.4)	RL=100Ω, RS=GND	CL=5pF,	f=135MHz,	65	71	mA
		RL=100Ω, RS=GND	CL=5pF,	f=160MHz,	73	80	mA
I <sub>TCCS</sub>	LVDS Transmitter Power Down Current	/PDWN=L, A	II Inputs=L or	Н	-	10	μA

\*Typ values are at the conditions of VCC=3.3V and  $Ta = +25^{\circ}C$ 

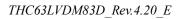
#### **Table 4. Power Consumption**

#### Worst Case Pattern



x=A,B,C,D

Figure 4. Worst Case Pattern





**Electrical Characteristics** 

#### **LVCMOS DC Specifications**

Over recommended operating supply and temperature range unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ*	Max	Unit
VIH	High Level Input Voltage	RS=VCC or GND	2.0	-	VCC	V
VIL	Low Level Input Voltage	RS=VCC or GND	GND	-	0.8	V
V <sub>DDQ</sub> <sup>1</sup>	Small Swing Voltage		1.2	-	2.8	V
V <sub>REF</sub>	Input Reference Voltage	Small Swing (RS=V <sub>DDQ</sub> /2)	-	$V_{DDQ}/2$	-	
V <sub>SH</sub> <sup>2</sup>	Small Swing High Level Input Voltage	$V_{REF=}V_{DDQ}/2$	V <sub>DDQ</sub> /2 +100m V	-	-	V
V <sub>SL</sub> <sup>2</sup>	Small Swing Low Level Input Voltage	$V_{\text{REF}} = V_{\text{DDQ}}/2$	-	-	V <sub>DDQ</sub> /2 -100mV	V
I <sub>INC</sub>	Input Current	$GND \leq V_{IN} \leq VCC$	-	-	±10	μA

\*Typ values are at the conditions of VCC=3.3V and Ta = +25°C

Notes :  ${}^{1}V_{DDQ}$  voltage defines the max voltage of small swing inputs at RS=VREF. It is not an actual input

voltage.

<sup>2</sup> Small swing signals are applied to TA0-6, TB0-6, TC0-6, TD0-6 and CLKIN.

Table 5. LV-CMOS DC Specifications

#### LVDS Transmitter DC Specifications

Over recommended operating supply and temperature range unless otherwise specified

Symbol	Parameter		nditions	Min	Тур*	Max	Unit
			Normal swing RS=VCC	250	350	450	mV
VOD	Differential Output Voltage	RL=100Ω	Reduced swing RS=GND	100	200	300	mV
ΔVOD	Change in VOD between complementary output states			-	-	35	mV
VOC	Common Mode Voltage	RL=100Ω		1.125	1.25	1.375	V
	Change in VOC between complementary output states			-	-	35	mV
I <sub>OS</sub>	Output Short Circuit Current	V <sub>OUT</sub> =GN	ND, RL=100Ω	-	-	-24	mA
I <sub>OZ</sub>	Output TRI-STATE Current		VN=GND, GND to VCC	-	-	±10	μA

\*Typ values are at the conditions of VCC=3.3V and Ta =  $+25^{\circ}C$ 

Table 6. LVDS Transmitter DC Specifications

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Over recommended operating supply and temperature range unless otherwise specified						
Symbol	Parameter	Min	Тур	Max	Unit	
t <sub>TCIT</sub>	CLK IN Transition Time	-	-	5.0	ns	
t <sub>TCP</sub>	CLK IN Period	6.25	Т	125	ns	
t <sub>TCH</sub>	CLK IN High Time	0.35T	0.5T	0.65T	ns	
t <sub>TCL</sub>	CLK IN Low Time	0.35T	0.5T	0.65T	ns	
t <sub>TCD</sub>	CLK IN to TCLK+/- Delay	-	3T	-	ns	
t <sub>TS</sub>	LVCMOS Data Setup to CLK IN	2.0	-	-	ns	
t <sub>TH</sub>	LVCMOS Data Hold from CLK IN	0.0	-	-	ns	
t <sub>LVT</sub>	LVDS Transition Time	-	0.6	1.5	ns	
t <sub>TOP1</sub>	Output Data Position0 (T=6.25ns ~ 20ns)	-0.15	0.0	+0.15	ns	
t <sub>Top0</sub>	Output Data Position1 (T=6.25ns ~ 20ns)	T/7-0.15	T/7	T/7+0.15	ns	
t <sub>Top6</sub>	Output Data Position2 (T=6.25ns ~ 20ns)	2T/7-0.15	2T/7	2T/7+0.15	ns	
t <sub>Top5</sub>	Output Data Position3 (T=6.25ns ~ 20ns)	3T/7-0.15	3T/7	3T/7+0.15	ns	
t <sub>Top4</sub>	Output Data Position4 (T=6.25ns ~ 20ns)	4T/7-0.15	4T/7	4T/7+0.15	ns	
t <sub>Top3</sub>	Output Data Position5 (T=6.25ns ~ 20ns)	5T/7-0.15	5T/7	5T/7+0.15	ns	
t <sub>Top2</sub>	Output Data Position6 (T=6.25ns ~ 20ns)	6T/7-0.15	6T/7	6T/7+0.15	ns	
t <sub>TPLL</sub>	Phase Lock Loop Set	-	-	10.0	ms	

#### LVCMOS & LVDS Transmitter AC Specifications

\*Typ values are at the conditions of VCC=3.3V and Ta = +25°C

Table 7. LVCMOS & LVDS Transmitter AC Specifications
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LVCMOS Input

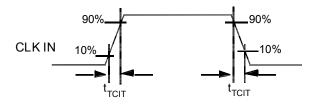
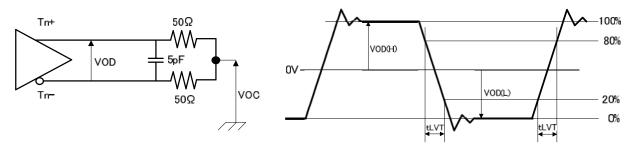


Figure 5. CLKIN Transmission Time

LVDS Output



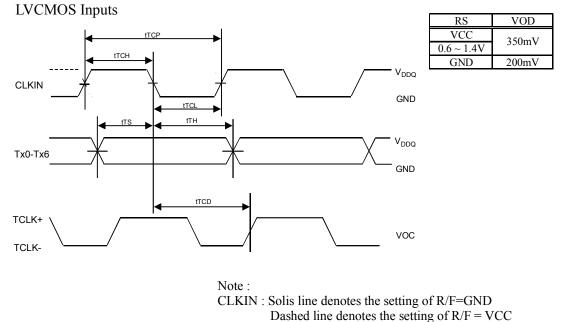
LVDS Output Load

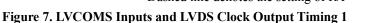


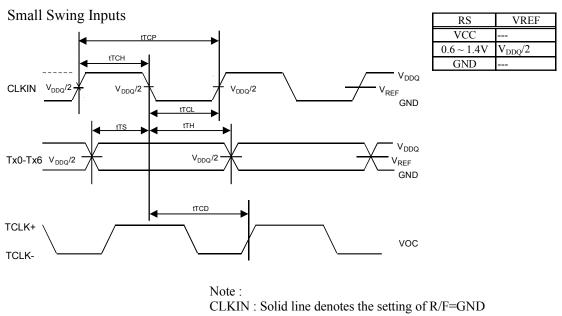
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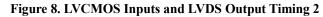
#### AC Timing Diagrams







Dashed line denotes the setting of R/F = VCC



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#### LVDS Output Data Position

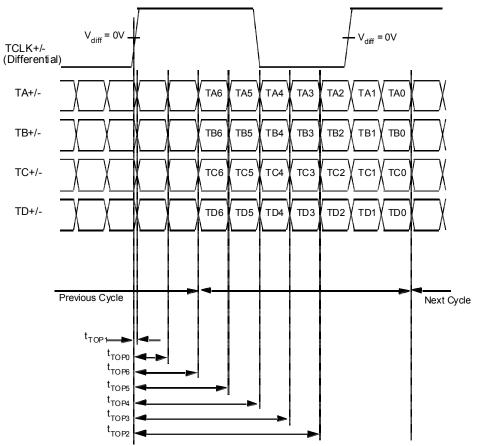
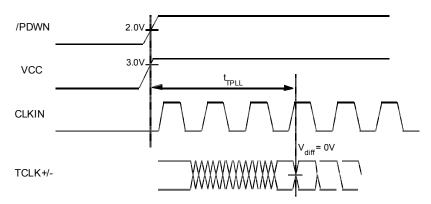


Figure 9. LVDS Output Data Position

Phase Lock Loop Set Time







#### Spread Spectrum Clocking Tolerant

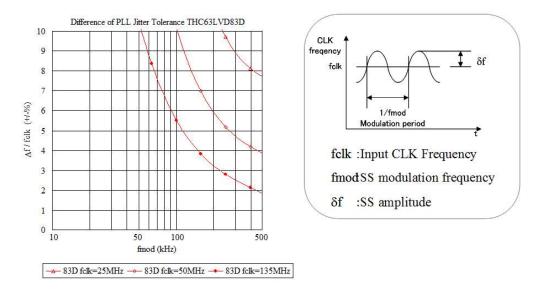
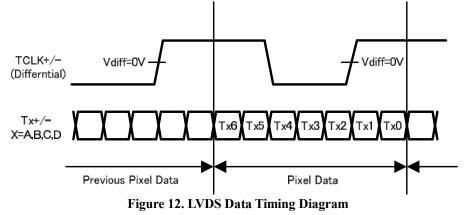


Figure 11. Spread Spectrum Clocking Tolerant

The graph indicates the range that the IC works normally under SS clock input operation. The results are measured with a typical sample on condition of +25C° and 3.3V, therefore these values are for reference and do not guarantee the performance of a product under other circumstance.



#### LVDS Data Timing Diagram



THC63LVDM83D Pixel Data Mapping for JEIDA Format (6bit, 8bit Application)

	6bit	8bit
TA0	R2	R2
TA1	R3	R3
TA2	R4	R4
TA3	R5	R5
TA4	R6	R6
TA5	R7	R7
TA6	G2	G2
TB0	G3	G3
TB1	G4	G4
TB2	G5	G5
TB3	G6	G6
TB4	G7	G7
TB5	B2	B2
TB6	B3	B3
TC0	B4	B4
TC1	B5	B5
TC2	B6	B6
TC3	B7	B7
TC4	Hsync	Hsync
TC5	Vsync DE	Vsync DE
TC6	DE	DE
TD0	-	R0
TD1 TD2 TD3	-	R1
TD2	-	G0
TD3	-	G1
TD4	-	B0
TD5	-	B1
TD6	-	N/A

Note : Use TA to TC channels and open TD channel for 6bit application. Table 8. Data Mapping for JEIDA Format



	6bit	8bit
TA0	R0	R0
TA1	R1	R1
TA2	R2	R2
TA3	R3	R3
TA4	R4	R4
TA5	R5	R5
TA6	G0	G0
TB0	G1	G1
TB1	G2	G2
TB2	G3	G3
TB3	G4	G4
TB4	G5	G5
TB5	B0	B0
TB6	B1	B1
TC0	B2	B2
TC1	B3	B3
TC2	B4	B4
TC3	B5	B5
TC4	Hsync	Hsync
TC5	Vsync	Vsync DE
TC6	DE	DE
TD0	-	R6
TD1	-	R7
TD2	-	G6
TD3	-	G7
TD4	-	B6
TD5	-	B7
TD6	-	N/A

THC63LVDM83D Pixel Data Mapping for VESA Format (6bit, 8bit Application)

Note : Use TA to TC channels and open TD channel for 6bit application. Table 9. Data Mapping for VESA Format



#### **Normal Connection**

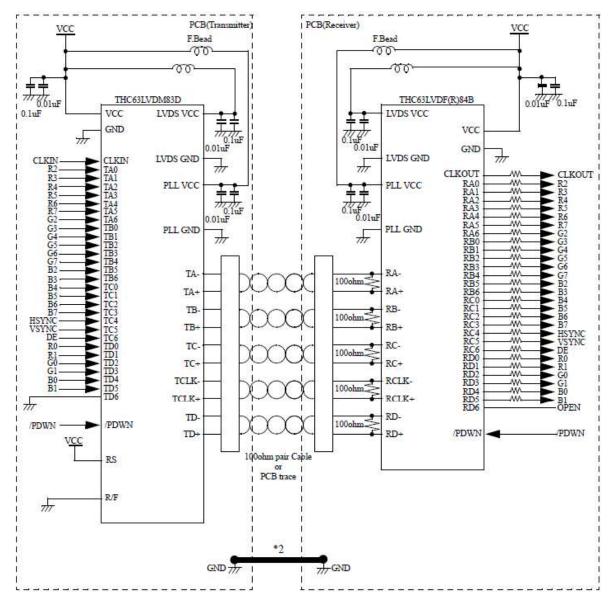


Figure 13. Typical Connection Diagram



#### Notes

- Cable Connection and Disconnection Do not connect and disconnect the LVDS cable, when the power is supplied to the system.
- 2) GND Connection

Connect each GND of the PCB which THC63LVDM83D and LVDS-Rx on it. It is better for EMI reduction to place GND cable as close to LVDS cable as possible.

#### 3) Multi Drop Connection

Multi drop connection is not recommended.

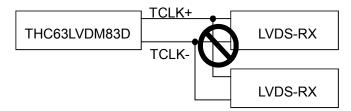
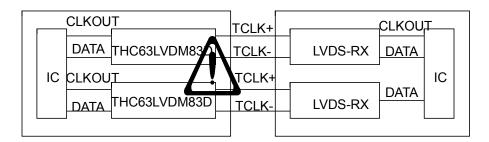


Figure 14. Multi Drop Connection

#### 4) Asynchronous use

Asynchronous using such as following systems is not recommended.



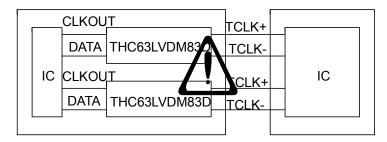
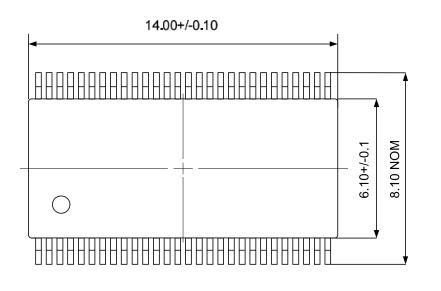


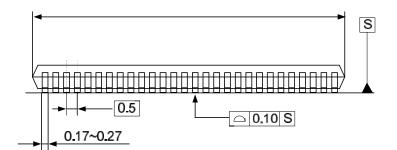
Figure 15. Asynchronous Use

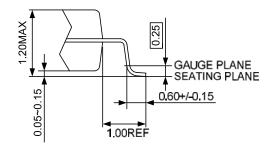
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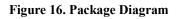
Package







UNIT:mm



#### THC63LVDM83D\_Rev.4.20\_E



#### Reference Land Pattern

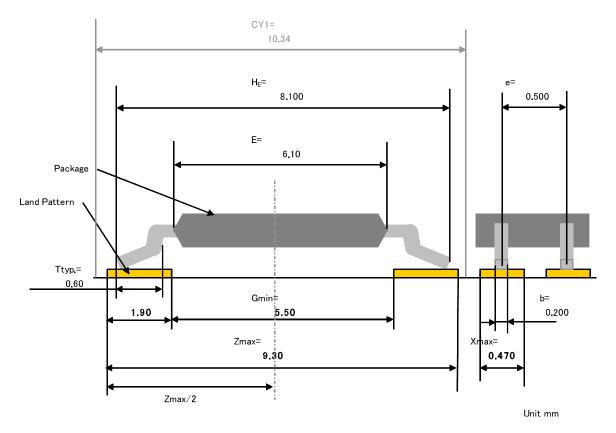


Figure 17. Reference of Land Pattern

The recommendation mounting method of THine device is reflow soldering. The reference pattern is using the calculation result on condition of reflow soldering.

Notes

This land pattern design is a calculated value based on JEITA ET-7501.

Please take into consideration in an actual substrate design about enough the ease of mounting, the intensity of connection, the density of mounting, and the solder paste used, etc... The optimal land pattern size changes with these parameters. Please use the value shown by the land pattern as reference data.



#### **Notices and Requests**

- 1. The product specifications described in this material are subject to change without prior notice.
- 2. The circuit diagrams described in this material are examples of the application which may not always apply to the customer's design. We are not responsible for possible errors and omissions in this material. Please note if errors or omissions should be found in this material, we may not be able to correct them immediately.
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- 5.3 THine accepts liability for demands and specifications of the Specified Product only to the extent that the user and THine have been previously and explicitly agreed to each other.
- 6. Despite our utmost efforts to improve the quality and reliability of the product, faults will occur with a certain small probability, which is inevitable to a semi-conductor product. Therefore, you are encouraged to have sufficiently redundant or error preventive design applied to the use of the product so as not to have our product cause any social or public damage.
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- 8. Testing and other quality control techniques are used to this product to the extent THine deems necessary to support warranty for performance of this product. Except where mandated by applicable law or deemed necessary by THine based on the user's request, testing of all functions and performance of the product is not necessarily performed.
- 9. Customers are asked, if required, to judge by themselves if this product falls under the category of strategic goods under the Foreign Exchange and Foreign Trade Control Law.
- 10. The product or peripheral parts may be damaged by a surge in voltage over the absolute maximum ratings or malfunction, if pins of the product are shorted by such as foreign substance. The damages may cause a smoking and ignition. Therefore, you are encouraged to implement safety measures by adding protection devices, such as fuses.

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